





November 2010

- Pletronics' OeD4 is from the OeXO[™] Series of temperature compensated voltage controlled crystal oscillator with a CMOS output.
- · Cut Tape -or- Tape and Reel packaging
- 3.2 x 5 mm LCC Ceramic Package
- Supply Voltage: 3.3V

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.10 grams Moisture Sensitivity Level: 1 As defined in J-STD-020D.1

Constall and laterage and at a decimed in 3-3 i D-02

Second Level Interconnect code: e4



Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

ESD Rating

Model	Minimum Voltage	Conditions
Human Body Model	1500	MIL-STD-883 Method 3115
Charged Device Model	1000	JESD 22-C101



November 2010

Part Marking:



1920 = 19.20MHz, the crystal frequency
yww = Year and Week of the crystal manufacture
PLE = Pletronics
X = Model number, normally a "B"
YWW = Year and Week of assembly of the TCXO
Z = internal factory code

The actual part number is OED4205-19.20M where the model number "205" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)
Font is Courier New
Bar code is 39-Full ASCII
The bar code will show the actual Part Number
(OED4205-19.20M)

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect

Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A



November 2010

Electrical Specification for specified Vcc= $3.3V \pm 5\%$ over the specified temperature range.

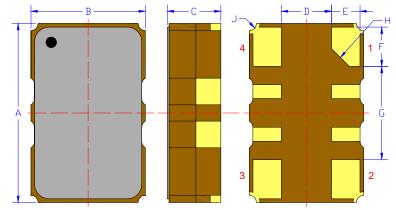
Item	Min	TYP	Max	Unit	Condition		
Frequency Stability over temperature	-50	-	50	ppb	Over 0°C to 70°C at fixed supply volta + load (reference to midpoint min/max frequency)		
Holdover	-50 -40	0	50 40	ppb ppb	Over 0°C to 70°C for Over ±5°C change fo		
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refle		
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage	
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5% 10 բ	oF <u>+</u> 10%	
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency	
Aging rate following reflow		±10 ±3 ±1		ppb/day	1 day after reflow 7 days after reflow 30 days after reflow		
Long term stability (Aging)	-1000 -1500 -4600		1000 1500 4600	ppb	after 1 year after 5 years after 15 years		
Output Waveform		CI	MOS				
Output V _{HIGH}	90	-	-	%Vs	Load: 10K ohm ±5% 10 pF ±10%		
Output V _{LOW}	-	-	10	%Vs	Vth: T _R and T _F 10% and 90% of amplitude		
T _{RISE} and T _{FALL}	•	•	6.5	nS	Vth: D.C. 50% of amp	olitude	
Duty Cycle	40	50	60	%			
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	25°C		
Jitter	ı	ı	0.6	pS	Frequency offset from	n carrier 12kHz to 20MHz	
V Supply Range ¹ V _{cc}	3.13	3.30	3.47	Volts			
Supply Current I _{CC}	-	-	3.0	mA			
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal		
Frequency Pullability	5	-	10	±ppm	Slope positive		
Linearity	-	0.05	2.0	%	In accordance with MIL-PRF-55310		
Operating Temperature	0	-	+70	°C	Widest range allowed	1	
Storage Temperature	-55	-	+95	°C			

Note: ¹ For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



November 2010

Mechanical:



	Inches	mm
Α	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20
В	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20
O	0.059 max	1.50 max
D ¹	0.0.55	1.40
E ¹	0.031	0.80
F ¹	0.043	1.10
G¹	0.102	2.60
H ¹	0.013C	0.50C
J ¹	0.008	0.20R

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to1.0 $\mu m)$

over

Nickel 50 to 350 µinches (1.27 to 8.89 µm)

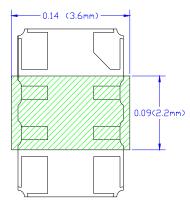
Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	CMOS
4	Supply Voltage (V _{CC})	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

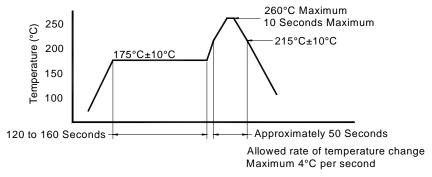
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device





November 2010

Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

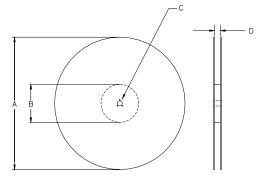
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

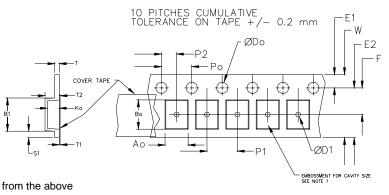
	Constant Dimensions Table 1							
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max
8mm		1.0			2.0			
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05			
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1
24mm		1.5			<u>+</u> 0.1			

		V	ariable Dimen	sions Table	2		
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





		REE	REEL DIMENSIONS				
Α	inches	7.0	10.0	13.0			
	mm	177.8	254.0	330.2			
В	inches	2.50	4.00	3.75			
	mm	63.5	101.6	95.3	Tape Width		
С	mm	13.0 +0.5 / -0.2					
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0		
	Reel dimensions may vary						

USER DIRECTION OF UNREELING -



November 2010

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Pletronics Incorporated (PLE) reserves the right to make corrections, improvements, modifications and other changes to this product at anytime. PLE reserves the right to discontinue any product or service without notice. Customers are responsible for obtaining the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to PLE's terms and conditions of sale supplied at the time of order acknowledgment.

PLE warrants performance of this product to the specifications applicable at the time of sale in accordance with PLE's limited warranty. Testing and other quality control techniques are used to the extent PLE deems necessary to support this warranty. Except where mandated by specific contractual documents, testing of all parameters of each product is not necessarily performed.

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Contacting Pletronics Inc.

Pletronics Inc. Tel: 425-776-1880 19013 36th Ave. West Fax: 425-776-2760

Lynnwood, WA 98036-5761 USA E-mail: ple-sales@pletronics.com

URL: <u>www.pletronics.com</u>

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Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.10 grams Moisture Sensitivity Level: 1 As defined in J-STD-020D.1

Second Level Interconnect code: e4



Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

ESD Rating

Model	Minimum Voltage	Conditions
Human Body Model	1500	MIL-STD-883 Method 3115
Charged Device Model	1000	JESD 22-C101



November 2010

Part Marking:



2000 = 20.00MHz, the crystal frequency
yww = Year and Week of the crystal manufacture
PLE = Pletronics
X = Model number, normally a "B"
YWW = Year and Week of assembly of the TCXO
Z = internal factory code

The actual part number is OED4206-20.00M where the model number "206" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)

Font is Courier New

Bar code is 39-Full ASCII

The bar code will show the actual Part Number

(OED4206-20.00M)

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A



November 2010

Electrical Specification for specified Vcc= $3.3V \pm 5\%$ over the specified temperature range.

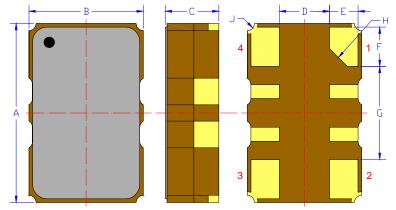
Item	Min	TYP	Max	Unit	Condition		
Frequency Stability over temperature	-50	-	50	ppb	Over 0°C to 70°C at fixed supply voltagent to the sup		
Holdover	-50 -40	0	50 40	ppb	Over 0°C to 70°C for Over ±5°C change fo		
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refle		
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage	
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5% 10 բ	oF <u>+</u> 10%	
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency	
Aging rate following reflow		±10 ±3 ±1	- - -	ppb/day	1 day after reflow 7 days after reflow 30 days after reflow		
Long term stability (Aging)	-1000 -1500 -4600		1000 1500 4600	ppb	after 1 year after 5 years after 15 years		
Output Waveform		CI	MOS				
Output V _{HIGH}	90	-	-	%Vs	Load: 10K ohm ±5% 10 pF ±10%		
Output V _{LOW}	-	-	10	%Vs	Vth: T _R and T _F 10% a	and 90% of amplitude	
T _{RISE} and T _{FALL}	•	•	6.5	nS	Vth: D.C. 50% of amp	olitude	
Duty Cycle	40	50	60	%			
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	at 25°C		
Jitter	•	•	0.6	pS	Frequency offset from	n carrier 12kHz to 20MHz	
V Supply Range ¹ V _{cc}	3.13	3.30	3.47	Volts			
Supply Current I _{CC}	-	-	3.0	mA			
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal		
Frequency Pullability	5	-	10	±ppm	Slope positive		
Linearity	-	0.05	2.0	%	In accordance with MIL-PRF-55310		
Operating Temperature	0	-	+70	°C	Widest range allowed	1	
Storage Temperature	-55	-	+95	°C			

Note: ¹ For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



November 2010

Mechanical:



	Inches	mm
Α	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20
В	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20
С	0.059 max	1.50 max
D ¹	0.0.55	1.40
E ¹	0.031	0.80
F ¹	0.043	1.10
G ¹	0.102	2.60
H ¹	0.013C	0.50C
J ¹	0.008	0.20R

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to1.0 $\mu m)$

over

Nickel 50 to 350 μinches (1.27 to 8.89 μm)

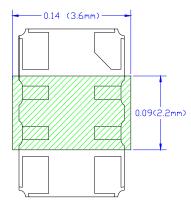
Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	CMOS
4	Supply Voltage (V _{CC})	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

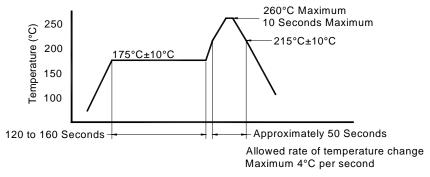
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device





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Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

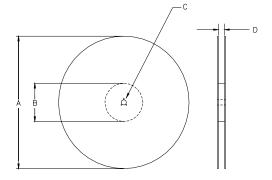
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

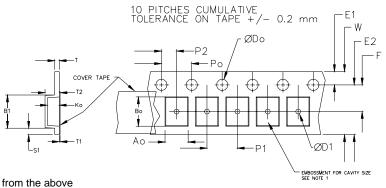
	Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max		
8mm		1.0			2.0					
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05					
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1		
24mm		1.5			<u>+</u> 0.1					

Variable Dimensions Table 2								
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko	
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1	

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





inches 7.0 10.0 13.0 177.8 254.0 330.2 mm inches 2.50 4.00 3.75 mm 63.5 101.6 95.3 13.0 +0.5 / -0.2 mm D 16.4 16.4 16.4 16.0 +2.0 +2.0

Reel dimensions may vary

REEL DIMENSIONS

USER DIRECTION OF UNREELING



November 2010

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PLE assumes no liability for application assistance or customer product design. Customers are responsible for their products and applications using PLE components. To minimize the risks associated with the customer products and applications, customers should provide adequate design and operating safeguards.

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Contacting Pletronics Inc.

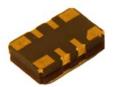
Pletronics Inc. Tel: 425-776-1880 19013 36th Ave. West Fax: 425-776-2760

Lynnwood, WA 98036-5761 USA E-mail: ple-sales@pletronics.com

URL: www.pletronics.com

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Second Level Interconnect code: e4



Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

ESD Rating

Model	Minimum Voltage	Conditions		
Human Body Model	1500	MIL-STD-883 Method 3115		
Charged Device Model	1000	JESD 22-C101		



November 2010

Part Marking:



2600 = 26.00MHz, the crystal frequency
yww = Year and Week of the crystal manufacture
PLE = Pletronics
X = Model number, normally a "B"
YWW = Year and Week of assembly of the TCXO
Z = internal factory code

The actual part number is OED4207-26.00M where the model number "207" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)
Font is Courier New
Bar code is 39-Full ASCII
The bar code will show the actual Part Number
(OED4207-26.00M)

P/N: DED4xxx-ff.ffM

Customer P/N: 123456

Qty: 1000

MSL: 1 OGD

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect

Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
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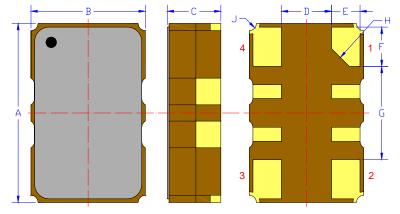
Item	Min	TYP	Max	Unit	Condition		
Frequency Stability over temperature	-50	-	50	ppb	Over 0°C to 70°C at fixed supply voltag + load (reference to midpoint min/max frequency)		
Holdover	-50 -40	0	50 40	ppb ppb	Over 0°C to 70°C for Over ±5°C change for		
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refle		
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage	
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5% 10 ¡	oF <u>+</u> 10%	
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency	
Aging rate following reflow	- - -	±10 ±3 ±1		ppb/day	1 day after reflow 7 days after reflow 30 days after reflow		
Long term stability (Aging)	-1000 -1500 -4600		1000 1500 4600	ppb	after 1 year after 5 years after 15 years		
Output Waveform	CMOS						
Output V _{HIGH}	90	-	-	%Vs	Load: 10K ohm <u>+</u> 5% 10 pF <u>+</u> 10%		
Output V _{LOW}	-	-	10	%Vs	Vth: T _p and T _p 10% a	and 90% of amplitude	
T_{RISE} and T_{FALL}	-	-	6.5	nS	Vth: D.C. 50% of am		
Duty Cycle	40	50	60	%			
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	at 25°C		
Jitter	-	-	0.6	pS	Frequency offset from	n carrier 12kHz to 20MHz	
V Supply Range ¹ V _{CC}	3.13	3.30	3.47	Volts			
Supply Current I _{CC}	-	-	3.0	mA			
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal		
Frequency Pullability	5	-	10	±ppm	Slope positive		
Linearity	-	0.05	2.0	%	In accordance with M	IIL-PRF-55310	
Operating Temperature	0	-	+70	°C	Widest range allowed	<u></u>	
Storage Temperature	-55	-	+95	°C			

Note: ¹ For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



November 2010

Mechanical:



	Inches	mm
Α	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20
В	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20
O	0.059 max	1.50 max
D ¹	0.0.55	1.40
E¹	0.031	0.80
F ¹	0.043	1.10
G ¹	0.102	2.60
H ¹	0.013C	0.50C
J ¹	0.008	0.20R

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to1.0 $\mu m)$

over

Nickel 50 to 350 µinches (1.27 to 8.89 µm)

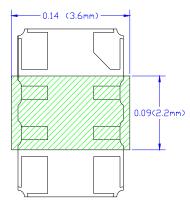
Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	CMOS
4	Supply Voltage (V _{CC})	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

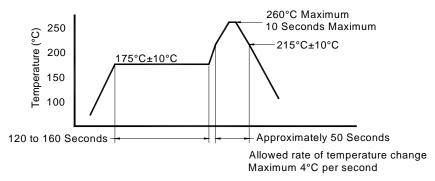
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device





November 2010

Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

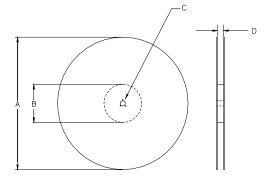
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

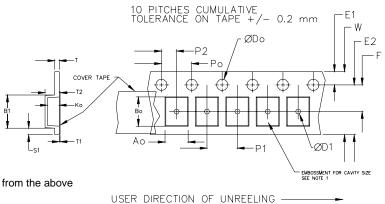
	Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max		
8mm		1.0			2.0					
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05					
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1		
24mm		1.5			<u>+</u> 0.1					

Variable Dimensions Table 2							
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





		REE				
Α	inches	7.0	10.0	13.0		
	mm	177.8	254.0	330.2		
В	inches	2.50	4.00	3.75		
	mm	63.5	101.6	95.3	Tape Width	
С	mm	13	13.0 +0.5 / -0.2			
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0	
	Reel dimensions may vary					



November 2010

IMPORTANT NOTICE

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PLE warrants performance of this product to the specifications applicable at the time of sale in accordance with PLE's limited warranty. Testing and other quality control techniques are used to the extent PLE deems necessary to support this warranty. Except where mandated by specific contractual documents, testing of all parameters of each product is not necessarily performed.

PLE assumes no liability for application assistance or customer product design. Customers are responsible for their products and applications using PLE components. To minimize the risks associated with the customer products and applications, customers should provide adequate design and operating safeguards.

PLE products are not designed, intended, authorized or warranted to be suitable for use in life support applications, devices or systems or other critical applications that may involve potential risks of death, personal injury or severe property or environmental damage. Inclusion of PLE products in such applications is understood to be fully at the risk of the customer. Use of PLE products in such applications requires the written approval of an appropriate PLE officer. Questions concerning potential risk applications should be directed to PLE.

PLE does not warrant or represent that any license, either express or implied, is granted under any PLE patent right, copyright, artwork or other intellectual property right relating to any combination, machine or process which PLE product or services are used. Information published by PLE regarding third-party products or services does not constitute a license from PLE to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from PLE under the patents or other intellectual property of PLE.

Reproduction of information in PLE data sheets or web site is permissible only if the reproduction is without alteration and is accompanied by associated warranties, conditions, limitations and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. PLE is not responsible or liable for such altered documents.

Resale of PLE products or services with statements different from or beyond the parameters stated by PLE for that product or service voids all express and implied warranties for the associated PLE product or service and is an unfair or deceptive business practice. PLE is not responsible for any such statements.

Contacting Pletronics Inc.

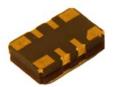
Pletronics Inc. Tel: 425-776-1880 19013 36th Ave. West Fax: 425-776-2760

Lynnwood, WA 98036-5761 USA E-mail: ple-sales@pletronics.com

URL: www.pletronics.com

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November 2010

- Pletronics' OeD4 is from the OeXO™ Series of temperature compensated voltage controlled crystal oscillator with a CMOS output.
- · Cut Tape -or- Tape and Reel packaging
- 3.2 x 5 mm LCC Ceramic Package
- Supply Voltage: 3.3V

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.10 grams Moisture Sensitivity Level: 1 As defined in J-STD-020D.1

Second Level Interconnect code: e4



Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{cc} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

ESD Rating

Model	Minimum Voltage	Conditions	
Human Body Model	1500	MIL-STD-883 Method 3115	
Charged Device Model	1000	JESD 22-C101	



November 2010

Part Marking:



2000 = 20.00MHz, the crystal frequency
yww = Year and Week of the crystal manufacture
PLE = Pletronics
X = Model number, normally a "B"
YWW = Year and Week of assembly of the TCXO
Z = internal factory code

The actual part number is OED4212-10.00M where the model number "212" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

Note that the crystal frequency is 2 times the specified frequency of 10.00MHz. The TCVCXO IC used divides the crystal frequency be 2 resulting in a 10.00MHz output

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)
Font is Courier New
Bar code is 39-Full ASCII
The bar code will show the actual Part Number
(OED4212-10.00M)

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A



November 2010

Electrical Specification for specified Vcc= 3.3V ±5% over the specified temperature range

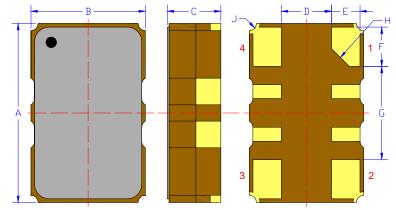
Item	Min	TYP	Max	Unit	Condition	
Frequency Stability over temperature	-250	-	250	ppb	Over -40°C to 85°C	at fixed supply voltage + load (reference to midpoint min/max frequency)
Holdover	-250 -125	0	250 125	ppb ppb	Over -40°C to 85°C for Over ±5°C change for	
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refle	
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5% 10 p	oF <u>+</u> 10%
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency
Aging rate following reflow	-	±10 ±3 ±1		ppb/day	1 day after reflow 7 days after reflow 30 days after reflow	
Long term stability (Aging)	-1000 -1500 -4600	-	1000 1500 4600	ppb	after 1 year after 5 years after 15 years	
Output Waveform	CMOS					
Output V _{HIGH}	90	-	-	%Vs	Load: 10K ohm ±5% 10 pF ±10%	
Output V _{LOW}	-	-	10	%Vs	Vth: T _p and T _p 10% a	and 90% of amplitude
T_{RISE} and T_{FALL}	-	-	6.5	nS	Vth: D.C. 50% of am	
Duty Cycle	40	50	60	%		
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	at 25°C	
Jitter	-	-	0.6	pS	Frequency offset from	n carrier 12kHz to 20MHz
V Supply Range ¹ V _{CC}	3.13	3.30	3.47	Volts		
Supply Current I _{CC}	-	-	3.0	mA		
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal	
Frequency Pullability	5	-	10	±ppm	Slope positive	
Linearity	-	0.05	2.0	%	In accordance with M	IIL-PRF-55310
Operating Temperature	-40	-	+85	°C	Widest range allowed	<u></u>
Storage Temperature	-55	-	+95	°C		

Note: ¹ For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



November 2010

Mechanical:



		Inches	mm
Δ	١.	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20
Е	3	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20
C	;	0.059 max	1.50 max
С) ¹	0.0.55	1.40
Е	1	0.031	0.80
F	1	0.043	1.10
G	3 ¹	0.102	2.60
H	l ¹	0.013C	0.50C
J	1	0.008	0.20R

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to1.0 $\mu m)$

over

Nickel 50 to 350 µinches (1.27 to 8.89 µm)

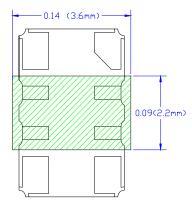
Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	смоѕ
4	Supply Voltage (V _{CC})	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

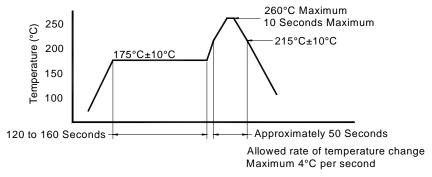
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device





November 2010

Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

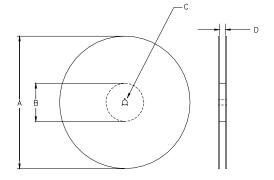
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

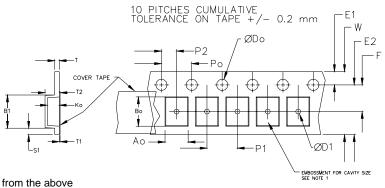
	Constant Dimensions Table 1							
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max
8mm		1.0			2.0			
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05			
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1
24mm		1.5			<u>+</u> 0.1			

Variable Dimensions Table 2							
Tape Size	B1 Max	E2 Min	F	P1	T2 Max	W Max	Ao, Bo & Ko
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





USER DIRECTION OF UNREELING -

		REE				
Α	inches	7.0	10.0	13.0		
	mm	177.8	254.0	330.2		
В	inches	2.50	4.00	3.75		
	mm	63.5	101.6	95.3	Tape Width	
С	mm	13	13.0 +0.5 / -0.2			
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0	
	Reel dimensions may vary					

Unit 1016 1



November 2010

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Contacting Pletronics Inc.

Pletronics Inc. Tel: 425-776-1880 19013 36th Ave. West Fax: 425-776-2760

Lynnwood, WA 98036-5761 USA E-mail: ple-sales@pletronics.com

URL: www.pletronics.com

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November 2010

- Pletronics' OeD4 is from the OeXO[™] Series of temperature compensated voltage controlled crystal oscillator with a CMOS output.
- Cut Tape -or- Tape and Reel packaging
- 3.2 x 5 mm LCC Ceramic Package
- Supply Voltage: 3.3V

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.10 grams Moisture Sensitivity Level: 1 As defined in J-STD-020D.1

Second Level Interconnect code: e4

Lead free

Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

ESD Rating

Model	Minimum Voltage	Conditions	
Human Body Model	1500	MIL-STD-883 Method 3115	
Charged Device Model	1000	JESD 22-C101	



November 2010

Part Marking:



1920 = 19.20MHz, the crystal frequency
yww = Year and Week of the crystal manufacture
PLE = Pletronics
X = Model number, normally a "B"
YWW = Year and Week of assembly of the TCXO
Z = internal factory code

The actual part number is OED4213-19.20M where the model number "213" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)
Font is Courier New
Bar code is 39-Full ASCII
The bar code will show the actual Part Number
(OED4213-19.20M)

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A



November 2010

Electrical Specification for specified Vcc= $3.3V \pm 5\%$ over the specified temperature range.

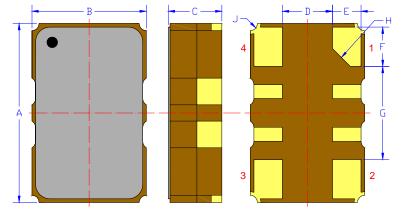
Item	Min	TYP	Max	Unit	Condition		
Frequency Stability over temperature	-250	-	250	ppb	Over -40°C to 85°C at fixed supply voltage + load (reference to midpoint min/max frequency)		
Holdover	-250 -125	0	250 125	ppb ppb	Over -40°C to 85°C for Over ±5°C change for		
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refl		
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage	
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5% 10	oF <u>+</u> 10%	
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency	
Aging rate following reflow	- - -	±10 ±3 ±1	- - -	ppb/day	1 day after reflow 7 days after reflow 30 days after reflow		
Long term stability (Aging)	-1000 -1500 -4600		1000 1500 4600	ppb	after 1 year after 5 years after 15 years		
Output Waveform		CI	MOS				
Output V _{HIGH}	90	-	-	%Vs	Load: 10K ohm ±5% 10 pF ±10%		
Output V _{LOW}	-	-	10	%Vs	Vth: T _p and T _p 10% a	and 90% of amplitude	
T_{RISE} and T_{FALL}	-	-	6.5	nS	Vth: D.C. 50% of am		
Duty Cycle	40	50	60	%			
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	at 25°C		
Jitter	-	-	0.6	pS	Frequency offset from	m carrier 12kHz to 20MHz	
V Supply Range ¹ V _{CC}	3.13	3.30	3.47	Volts			
Supply Current I _{CC}	-	-	3.0	mA			
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal		
Frequency Pullability	5	-	10	±ppm	Slope positive		
Linearity	-	0.05	2.0	%	In accordance with M	IIL-PRF-55310	
Operating Temperature	-40	-	+85	°C	Widest range allowed	d	
Storage Temperature	-55	-	+95	°C	r should be pleased now		

Note: ¹ For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



November 2010

Mechanical:



	Inches	mm
Α	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20
В	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20
С	0.059 max	1.50 max
D ¹	0.0.55	1.40
E ¹	0.031	0.80
F¹	0.043	1.10
G ¹	0.102	2.60
H ¹	0.013C	0.50C
J ¹	0.008	0.20R

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to1.0 $\mu m)$

over

Nickel 50 to 350 µinches (1.27 to 8.89 µm)

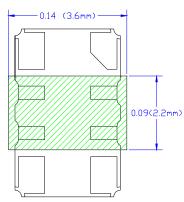
Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	CMOS
4	Supply Voltage (V _{CC})	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

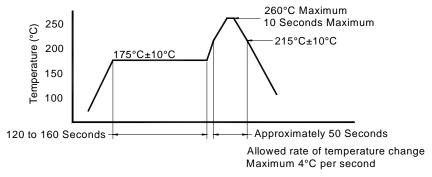
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device





November 2010

Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

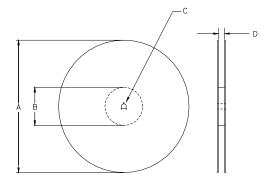
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

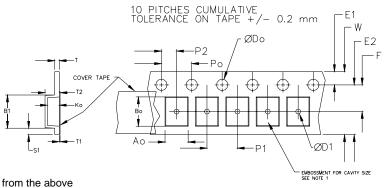
Constant Dimensions Table 1								
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max
8mm		1.0			2.0			
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05			
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1
24mm		1.5			<u>+</u> 0.1			

Variable Dimensions Table 2									
Tape Size B1 Max E2 Min F P1 T2 Max W Max Ao, Bo & Ko									
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1		

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





		REE					
Α	inches	7.0 10.0 13.0					
	mm	177.8	254.0	330.2			
В	inches	2.50	4.00	3.75			
	mm	63.5	63.5 101.6		Tape Width		
С	mm	13	Width				
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0		
Reel dimensions may vary							

USER DIRECTION OF UNREELING -



November 2010

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PLE warrants performance of this product to the specifications applicable at the time of sale in accordance with PLE's limited warranty. Testing and other quality control techniques are used to the extent PLE deems necessary to support this warranty. Except where mandated by specific contractual documents, testing of all parameters of each product is not necessarily performed.

PLE assumes no liability for application assistance or customer product design. Customers are responsible for their products and applications using PLE components. To minimize the risks associated with the customer products and applications, customers should provide adequate design and operating safeguards.

PLE products are not designed, intended, authorized or warranted to be suitable for use in life support applications, devices or systems or other critical applications that may involve potential risks of death, personal injury or severe property or environmental damage. Inclusion of PLE products in such applications is understood to be fully at the risk of the customer. Use of PLE products in such applications requires the written approval of an appropriate PLE officer. Questions concerning potential risk applications should be directed to PLE.

PLE does not warrant or represent that any license, either express or implied, is granted under any PLE patent right, copyright, artwork or other intellectual property right relating to any combination, machine or process which PLE product or services are used. Information published by PLE regarding third-party products or services does not constitute a license from PLE to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from PLE under the patents or other intellectual property of PLE.

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Contacting Pletronics Inc.

Pletronics Inc. Tel: 425-776-1880 19013 36th Ave. West Fax: 425-776-2760

Lynnwood, WA 98036-5761 USA E-mail: ple-sales@pletronics.com

URL: <u>www.pletronics.com</u>

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November 2010

- Pletronics' OeD4 is from the OeXO™ Series of temperature compensated voltage controlled crystal oscillator with a CMOS output.
- · Cut Tape -or- Tape and Reel packaging
- 3.2 x 5 mm LCC Ceramic Package
- Supply Voltage: 3.3V

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.10 grams Moisture Sensitivity Level: 1 As defined in J-STD-020D.1

Second Level Interconnect code: e4



Absolute Maximum Ratings:

Parameter	Unit		
V _{cc} Supply Voltage	-0.5V to +6.5V		
Vi Input Voltage	-0.5V to V _{CC} + 0.5V		
Vo Output Voltage	-0.5V to V _{cc} + 0.5V		

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

ESD Rating

Model	Minimum Voltage	Conditions	
Human Body Model	1500	MIL-STD-883 Method 3115	
Charged Device Model	1000	JESD 22-C101	



November 2010

Part Marking:



2000 = 20.00MHz, the crystal frequency
yww = Year and Week of the crystal manufacture
PLE = Pletronics
X = Model number, normally a "B"
YWW = Year and Week of assembly of the TCXO
Z = internal factory code

The actual part number is OED4214-20.00M where the model number "214" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm)

Font is Courier New

Bar code is 39-Full ASCII

The bar code will show the actual Part Number

(OED4214-20.00M)

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect

Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A



November 2010

Electrical Specification for specified Vcc= $3.3V \pm 5\%$ over the specified temperature range.

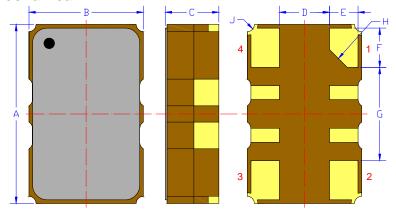
Item	Min	TYP	Max	Unit	Condition		
Frequency Stability over temperature	-250	-	250	ppb	Over -40°C to 85°C at fixed supply voltage + load (reference to midpoint min/max frequency)		
Holdover	-250 -125	0	250 125	ppb	Over -40°C to 85°C for Over +5°C change for		
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refle		
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage	
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5% 10 բ	oF <u>+</u> 10%	
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency	
Aging rate following reflow		±10 ±3 ±1		ppb/day	1 day after reflow 7 days after reflow 30 days after reflow		
Long term stability (Aging)	-1000 -1500 -4600		1000 1500 4600	ppb	after 1 year after 5 years after 15 years		
Output Waveform		CI	MOS				
Output V _{HIGH}	90	-	-	%Vs	Load: 10K ohm ±5% 10 pF ±10%		
Output V _{LOW}	-	-	10	%Vs	Vth: T _R and T _F 10% and 90% of amplitude		
T_{RISE} and T_{FALL}	-	-	6.5	nS	Vth: D.C. 50% of amp	olitude	
Duty Cycle	40	50	60	%			
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	at 25°C		
Jitter	-	-	0.6	pS	Frequency offset from	n carrier 12kHz to 20MHz	
V Supply Range ¹ V _{cc}	3.13	3.30	3.47	Volts			
Supply Current I _{CC}	-	-	3.0	mA			
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal		
Frequency Pullability	5	-	10	±ppm	Slope positive		
Linearity	-	0.05	2.0	%	In accordance with M	IIL-PRF-55310	
Operating Temperature	-40	-	+85	°C	Widest range allowed	1	
Storage Temperature	-55	-	+95	°C			

Note: ¹ For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



November 2010

Mechanical:



		Inches	mm				
	Α	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20				
	В	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20				
	С	0.059 max	1.50 max				
	D ¹	0.0.55	1.40				
	E¹	0.031	0.80				
	F¹	0.043	1.10				
	G¹	0.102	2.60				
	H ¹	0.013C	0.50C				
	J^1	0.008	0.20R				

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to1.0 $\mu m)$

over

Nickel 50 to 350 µinches (1.27 to 8.89 µm)

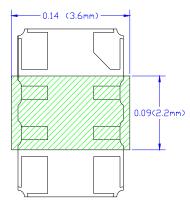
Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	CMOS
4	Supply Voltage (V _{CC})	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

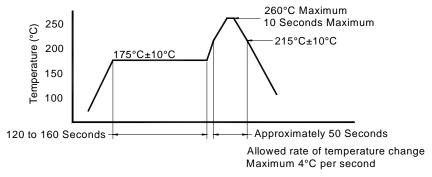
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device





November 2010

Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

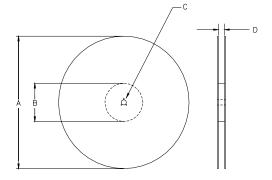
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

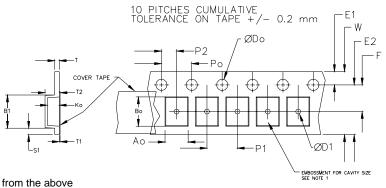
	Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max		
8mm		1.0			2.0					
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05					
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1		
24mm		1.5			<u>+</u> 0.1					

Variable Dimensions Table 2									
Tape B1 E2 Min Size Max		F	P1	T2 Max	W Max	Ao, Bo & Ko			
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1		

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





inches 7.0 10.0 13.0 177.8 254.0 330.2 mm inches 2.50 4.00 3.75 mm 63.5 101.6 95.3 13.0 +0.5 / -0.2 mm D 16.4 16.4 16.4 16.0 +2.0 +2.0 Reel dimensions may vary

REEL DIMENSIONS

USER DIRECTION OF UNREELING -



November 2010

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Lynnwood, WA 98036-5761 USA E-mail: ple-sales@pletronics.com

URL: <u>www.pletronics.com</u>

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November 2010

- Pletronics' OeD4 is from the OeXO™ Series of temperature compensated voltage controlled crystal oscillator with a CMOS output.
- · Cut Tape -or- Tape and Reel packaging
- 3.2 x 5 mm LCC Ceramic Package
- Supply Voltage: 3.3V

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.10 grams Moisture Sensitivity Level: 1 As defined in J-STD-020D.1

Second Level Interconnect code: e4



Absolute Maximum Ratings:

Parameter	Unit
V _{cc} Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V _{CC} + 0.5V
Vo Output Voltage	-0.5V to V _{CC} + 0.5V

Thermal Characteristics

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

ESD Rating

Model	Minimum Voltage	Conditions		
Human Body Model	1500	MIL-STD-883 Method 3115		
Charged Device Model	1000	JESD 22-C101		



November 2010

Part Marking:



1920 = 26.00MHz, the crystal frequency
yww = Year and Week of the crystal manufacture
PLE = Pletronics
X = Model number, normally a "B"
YWW = Year and Week of assembly of the TCXO
Z = internal factory code

The actual part number is OED4215-26.00M where the model number "215" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

Package Labeling

MSL: 1

Label is 1" x 2.6" (25.4mm x 66.7mm)
Font is Courier New
Bar code is 39-Full ASCII
The bar code will show the actual Part Number
(OED4215-26.00M)

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect

Category=e4

Max Safe Temp=260C for 10s 2X Max

Reliability: Environmental Compliance

Parameter	Condition		
Mechanical Shock	MIL-STD-883 Method 2002, Condition B		
Vibration	MIL-STD-883 Method 2007, Condition A		
Solderability	MIL-STD-883 Method 2003		
Thermal Shock	MIL-STD-883 Method 1011, Condition A		



November 2010

Electrical Specification for specified Vcc= $3.3V \pm 5\%$ over the specified temperature range.

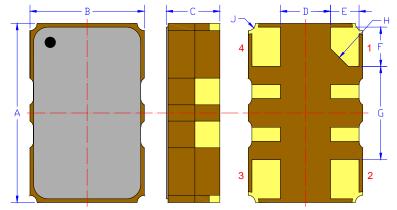
Item	Min	TYP	Max	Unit	Condition		
Frequency Stability over temperature	-250	-	250	ppb	Over -40°C to 85°C at fixed supply voltage + load (reference to midpoint min/max frequency)		
Holdover	-250 -125	0	250 125	ppb ppb	Over -40°C to 85°C for Over +5°C change for		
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refle		
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage	
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5% 10 բ	oF <u>+</u> 10%	
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency	
Aging rate following reflow		±10 ±3 ±1		ppb/day	1 day after reflow 7 days after reflow 30 days after reflow		
Long term stability (Aging)	-1000 -1500 -4600		1000 1500 4600	ppb	after 1 year after 5 years after 15 years		
Output Waveform	CMOS						
Output V _{HIGH}	90	-	-	%Vs	Load: 10K ohm ±5% 10 pF ±10%		
Output V _{LOW}	-	-	10	%Vs	Vth: T_R and T_F 10% and 90% of amplitude Vth: D.C. 50% of amplitude		
T_{RISE} and T_{FALL}	•	•	6.5	nS			
Duty Cycle	40	50	60	%			
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	at 25°C		
Jitter	-	-	0.6	pS	Frequency offset from	n carrier 12kHz to 20MHz	
V Supply Range ¹ V _{CC}	3.13	3.30	3.47	Volts			
Supply Current I _{CC}	-	-	3.0	mA			
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal		
Frequency Pullability	5	-	10	±ppm	Slope positive		
Linearity	-	0.05	2.0	%	In accordance with M	IIL-PRF-55310	
Operating Temperature	-40	-	+85	°C	Widest range allowed	3	
Storage Temperature	-55	-	+95	°C			

Note: ¹ For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



November 2010

Mechanical:



	Inches	mm
	Iliches	111111
Α	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20
В	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20
С	0.059 max	1.50 max
D ¹	0.0.55	1.40
E ¹	0.031	0.80
F¹	0.043	1.10
G ¹	0.102	2.60
H ¹	0.013C	0.50C
J ¹	0.008	0.20R

Not to Scale

¹ Typical dimensions

Contacts:

Gold 11.8 to 39.4 $\mu inches$ (0.3 to1.0 $\mu m)$

over

Nickel 50 to 350 µinches (1.27 to 8.89 µm)

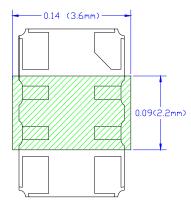
Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	CMOS
4	Supply Voltage (V _{CC})	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

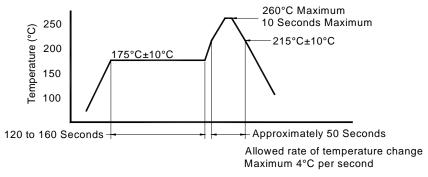
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device





November 2010

Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

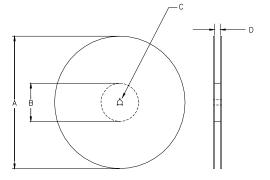
Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

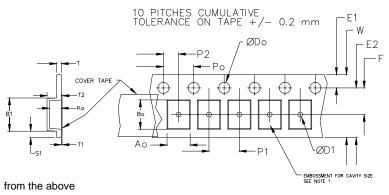
	Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max		
8mm		1.0			2.0					
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05					
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1		
24mm		1.5			<u>+</u> 0.1					

Variable Dimensions Table 2									
Tape Size			F	P1	T2 Max	W Max	Ao, Bo & Ko		
16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1		

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm Not to scale





		REEL DIMENSIONS			
Α	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
В	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13.0 +0.5 / -0.2			vvidiii
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0
Reel dimensions may va					

USER DIRECTION OF UNREELING -



November 2010

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